



HAC TEST REPORT

Applicant	Lemobile Information Technology (Beijing) Co., Ltd
FCC ID	2AFWMLEX522
Product	Mobile Phone
Brand	LeEco
Model	Le X522
Report No.	RXA1604-0079HAC01
Issue Date	May 25, 2016

TA Technology (Shanghai) Co., Ltd. tested the above equipment in accordance with the requirements in **ANSI C63.19-2011**. The test results show that the equipment tested is capable of demonstrating compliance with the requirements as documented in this report.

Jiang peng Lan

Approved by: Jiangpeng Lan

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Reviewed by: Kai Xu



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1 Test Laboratory

1.1 Notes of the Test Report

This report shall not be reproduced in full or partial, without the written approval of **TA technology (shanghai) co., Ltd**). The results documented in this report apply only to the tested sample, under the conditions and modes of operation as described herein. Measurement Uncertainties were not taken into account and are published for informational purposes only. This report is written to support regulatory compliance of the applicable standards stated above. This report must not be used by the client to claim product certification, approval, or endorsement by CNAS or any government agencies.

1.2 Test facility

CNAS (accreditation number: L2264)

TA Technology (Shanghai) Co., Ltd. has obtained the accreditation of China National Accreditation Service for Conformity Assessment (CNAS).

FCC (recognition number is 428261)

TA Technology (Shanghai) Co., Ltd. has been listed on the US Federal Communications Commission list of test facilities recognized to perform electromagnetic emissions measurements.

IC (recognition number is 8510A)

TA Technology (Shanghai) Co., Ltd. has been listed by industry Canada to perform electromagnetic emission measurement.

VCCI (recognition number is C-4595, T-2154, R-4113, G-766)

TA Technology (Shanghai) Co., Ltd. has been listed by industry Japan to perform electromagnetic emission measurement.

A2LA (Certificate Number: 3857.01)

TA Technology (Shanghai) Co., Ltd. has been listed by American Association for Laboratory Accreditation to perform electromagnetic emission measurement.



1.3 Testing Location

Company: TA Technology (Shanghai) Co., Ltd.
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City: Shanghai
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1.4 Laboratory Environment

Temperature	Min. = 18°C, Max. = 28 °C
Relative humidity	Min. = 0%, Max. = 80%
Ground system resistance	< 0.5 Ω
Ambient noise is checked and found very low and in compliance with requirement of standards. Reflection of surrounding objects is minimized and in compliance with requirement of standards.	



2 Statement of Compliance

Table 2.1: The Total M-rating of each tested band

Mode	Rating
GSM 850	M4
GSM 1900	M4
Date of Testing: May 5, 2016	

3 Description of Equipment under Test

Client Information

Applicant	Lemobile Information Technology (Beijing) Co., Ltd
Applicant address	WENHUAYING NORTH (No.1, LINKONG 2nd St), GAOLIYING, SHUNYI DISTRICT, BEIJING, CHINA
Manufacturer	Lemobile Information Technology (Beijing) Co., Ltd
Manufacturer address	WENHUAYING NORTH (No.1, LINKONG 2nd St), GAOLIYING, SHUNYI DISTRICT, BEIJING, CHINA

**General Technologies**

Device Type:	Portable Device	
State of Sample:	Prototype Unit	
Model:	Le X522	
IMEI:	SIM1:869944020029483 SIM2:869944020029491	
Hardware Version:	V1.0	
Software Version:	full_x526_S2_USA_eng_20160218	
Antenna Type:	Internal Antenna	
Device Operating Configurations :		
Tested Mode(s):	GSM 850/GSM 1900; WCDMA Band II/V	
Test Modulation:	(GSM)GMSK;	
Operating Frequency Range(s):	Mode	Tx (MHz)
	GSM 850	824.2 ~ 848.8
	GSM 1900	1850.2 ~ 1909.8
	WCDMA Band II	1852.4 ~ 1907.6
	WCDMA Band V	826.4 ~ 846.6
Power Class:	GSM 850: 4, GSM 1900: 1 WCDMA Band II/V: 3	
Power Level	GSM 850: level 5, GSM 1900: level 0 WCDMA Band II/V: Tested with Power Control All up bits	
Test Channel/ Frequency(MHz): (Low - Middle - High)	128/824.2 – 190/836.6 – 251/848.8 (GSM 850) 512/1850.2 – 661/1880 – 810/1909.8 (GSM 1900)	
Accessory Equipment		
Battery	Manufacturer: SCUD (Fujian) Electronics Co., Ltd. Model: LTF21A Power Rating: DC 3.83V, 3000mAh, Li-ion	



Air-Interface	Band (MHz)	Type	HAC tested	Simultaneous Transmissions Note: Not to be tested	Reduced power 20.19(c)(1)	Voice Over Digital Transport (Data)
GSM	850	VO	Yes	Yes Wi-Fi	NA	NA
	1900	VO			NO	NA
WCDMA	Band II	VO	NO [#]	Yes Wi-Fi	NA	NA
	Band V	VO	NO [#]		NA	NA
Bluetooth (BT)	2450	DT	NA	Yes Wi-Fi	NA	NA
Wi-Fi	2450	DT	NA	Yes GSM/WCDMA/BT	NA	NA
VO Voice CMRS/PSTN Service only V/D Voice CMRS/PSTN and Data Service DT Digital Transport				#: Evaluated for MIF and Low power exemption Rating was based on concurrent voice and		



4 Test Specification and Operational Conditions

4.1 Test Specification

The tests documented in this report were performed in accordance with the following:

ANSI C63.19-2011

KDB 285076 D01 HAC Guidance v04

KDB 285076 D02 T-Coil testing for CMRS IP v01r01

5 Test Information

5.1 Operational Conditions during Test

5.1.1 General Description of Test Procedures

The phone was tested in all normal configurations for the ear use. The EUT is mounted in the device holder equivalent as for classic dosimeter measurements. The acoustic output of the EUT shall coincide with the center point of the area formed by the dielectric wire and the middle bar of the arch's top frame. The EUT shall be moved vertically upwards until it touches the frame. The fine adjustment is possible by sliding the complete. The EUT holder is on the yellow base plate of the Test Arch phantom. These test configurations are tested at the high, middle and low frequency channels of each applicable operating mode; for example, GSM, WCDMA (UMTS), CDMA and TDMA.

No associated T-coil measurement has been made in accordance with the guidance issued by OET in KDB publication 285076 D02 T-Coil testing for CMRS IP.

5.1.2 GSM Test Configuration

A communication link is set up with a System Simulator (SS) by air link, and a call is established. The EUT is commanded to operate at maximum transmitting power. Using E5515C the power lever is set to "5" for GSM 850, set to "0" for GSM 1900. The test in the bands of GSM 850 and GSM 1900 are performed in the mode of speech transfer function.

5.2 HAC RF Measurements System Configuration

5.2.1 HAC Measurement Set-up

These measurements are performed using the DASY5 automated dosimetric assessment system. It is made by Schmid & Partner Engineering AG (SPEAG) in Zurich, Switzerland. It consists of high precision robotics system (Stäubli), robot controller, Intel Core2 computer, near-field probe, probe alignment sensor. The robot is a six-axis industrial robot performing precise movements. Cell controller systems contain the power supply, robot controller, teach pendant (Joystick) and remote control, and are used to drive the robot motors. The Stäubli Robot is connected to the cell controller to allow software manipulation of the robot. A data acquisition electronic (DAE) circuit performs the signal amplification; signal multiplexing, AD-conversion, offset measurements, mechanical surface detection, collision detection, etc. is connected to the Electro-optical coupler (EOC). The EOC performs the conversion from the optical into digital electric signal of the DAE and transfers data to the PC plug-in card.

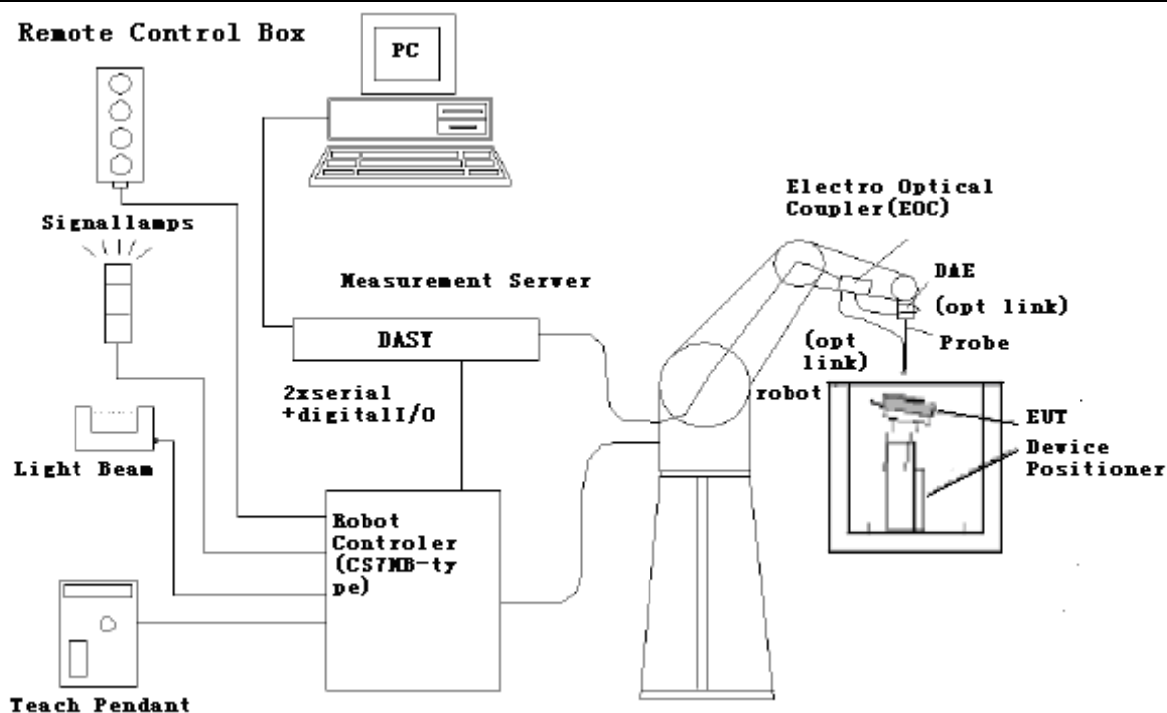


Figure 1 HAC Test Measurement Set-up

The DAE4 consists of a highly sensitive electrometer-grade preamplifier with auto-zeroing, a channel and gain-switching multiplexer, a fast 16 bit AD-converter and a command decoder and control logic unit. Transmission to the PC-card is accomplished through an optical downlink for data and status information and an optical uplink for commands and clock lines. The mechanical probe mounting device includes two different sensor systems for frontal and sidewise probe contacts. They are also used for mechanical surface detection and probe collision detection. The robot uses its own controller with a built in VME-bus computer.

5.2.2 Probe System

The HAC measurements were conducted with the E-Field Probe ER3DV6 and the H-Field Probe H3DV6 (manufactured by SPEAG), designed in the classical triangular configuration and optimized for dosimetric evaluation.

E-Field Probe Description

Construction	One dipole parallel, two dipoles normal to probe axis Built-in shielding against static charges PEEK enclosure material
Calibration	In air from 100 MHz to 3.0 GHz (absolute accuracy $\pm 6.0\%$, $k=2$)
Frequency	40 MHz to > 6 GHz (can be extended to < 20 MHz) Linearity: ± 0.2 dB (100 MHz to 3 GHz)
Directivity	± 0.2 dB in air (rotation around probe axis) ± 0.4 dB in air (rotation normal to probe axis)
Dynamic Range	2 V/m to > 1000 V/m; Linearity: ± 0.2 dB
Dimensions	Overall length: 330 mm (Tip: 16 mm) Tip diameter: 8 mm (Body: 12 mm) Distance from probe tip to dipole centers: 2.5 mm
Application	General near-field measurements up to 6 GHz Field component measurements Fast automatic scanning in phantoms



Figure 2 ER3DV6 E-field Probe

5.2.3 Test Arch Phantom & Phone Positioner

The Test Arch phantom should be positioned horizontally on a stable surface. Reference markings on the Phantom allow the complete setup of all predefined phantom positions and measurement grids by manually teaching three points in the robot. It enables easy and well defined positioning of the phone and validation dipoles as well as simple teaching of the robot (Dimensions: 370 x 370 x 370 mm). The Device reference point is set for the EUT at 6.3 mm, the Grid reference point is on the upper surface at the origin of the coordinates, and the “user point \Height Check 0.5 mm” is 0.5mm above the center, allowing verification of the gap of 0.5mm while the probe is positioned there.

The Phone Positioner supports accurate and reliable positioning of any phone with effect on near field $< \pm 0.5$ dB.

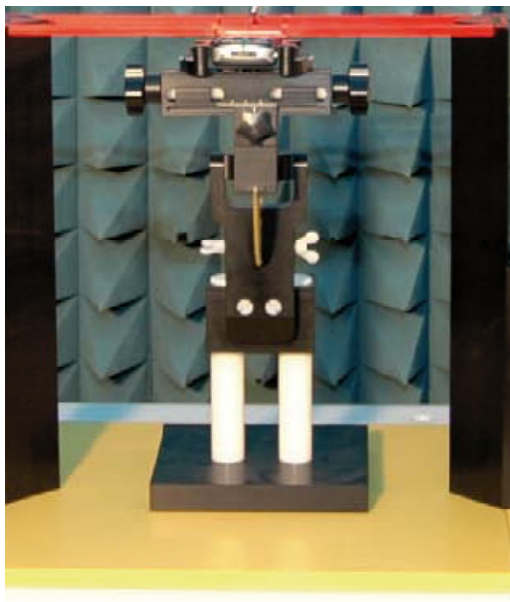


Figure 3 HAC Phantom & Device Holder

5.3 RF Test Procedures

The evaluation was performed with the following procedure:

1. Confirm proper operation of the field probe, probe measurement system and other instrumentation and the positioning system.
2. Position the WD in its intended test position. The gauge block can simplify this positioning. Note that a separate E-field gauge block will be needed if the center of the probe sensor elements is at different distances from the tip of the probe.
3. Configure the WD normal operation for maximum rated RF output power, at the desired channel and other operating parameters (e.g., test mode), as intended for the test.
4. The center sub-grid shall center on the center of the axial measurement point or the acoustic output, as appropriate. Locate the field probe at the initial test position in the 50 mm by 50 mm grid, which is contained in the measurement plane. If the field alignment method is used, align the probe for maximum field reception.
5. Record the reading.
6. Scan the entire 50 mm by 50 mm region in equally spaced increments and record the reading at each measurement point. The grid is 5 cm by 5 cm area that is divided into 9 evenly sized blocks or sub-grids. The distance between measurement points shall be sufficient to assure the identification of the maximum reading.
7. Identify the five contiguous sub-grids around the center sub-grid with the lowest maximum field strength readings. Thus the six areas to be used to determine the WD's highest emissions are identified and outlined for the final manual scan. Please note that a maximum of five blocks can be excluded for both E-field measurements for the WD output being measured. Stated another way, the center sub-grid and three others must be common to both the E-field measurements.
8. Identify the maximum field reading within the non-excluded sub-grids identified in Step 7.
9. Convert the maximum field strength reading identified in Step 8 to V/m or A/m, as appropriate. For probes which require a probe modulation factor, this conversion shall be done using the

- appropriate probe modulation factor and the calibration.
10. Repeat Step 1 through Step 10 for both the E-field measurements.
 11. Compare this reading to the categories in ANSI C63.19 Clause 8 and record the resulting category. The lowest category number listed in 8.2, Table 8.3 obtained in Step 10 for either E-field determines the M category for the audio coupling mode assessment. Record the WD category rating.



Figure 4 WD reference and plane for RF emission measurements

5.4 System Check

Validation Procedure

Place a dipole antenna meeting the requirements given in ANSI C63.19 D.11 in the position normally occupied by the WD. The dipole antenna serves as a known source for an electrical output. Position the E-field probe so that:

The probes and their cables are parallel to the coaxial feed of the dipole antenna.

The probe cables and the coaxial feed of the dipole antenna approach the measurement area from opposite directions.

Position the E-field probe at a 15 mm distance from the center of the probe element to the top surface. Validation was performed to verify that measured E-field is within +/-18% from the target reference values provided by the manufacturer. "Values within +/-18% are acceptable. Of which 12% is deviation and 13% is measurement uncertainty."

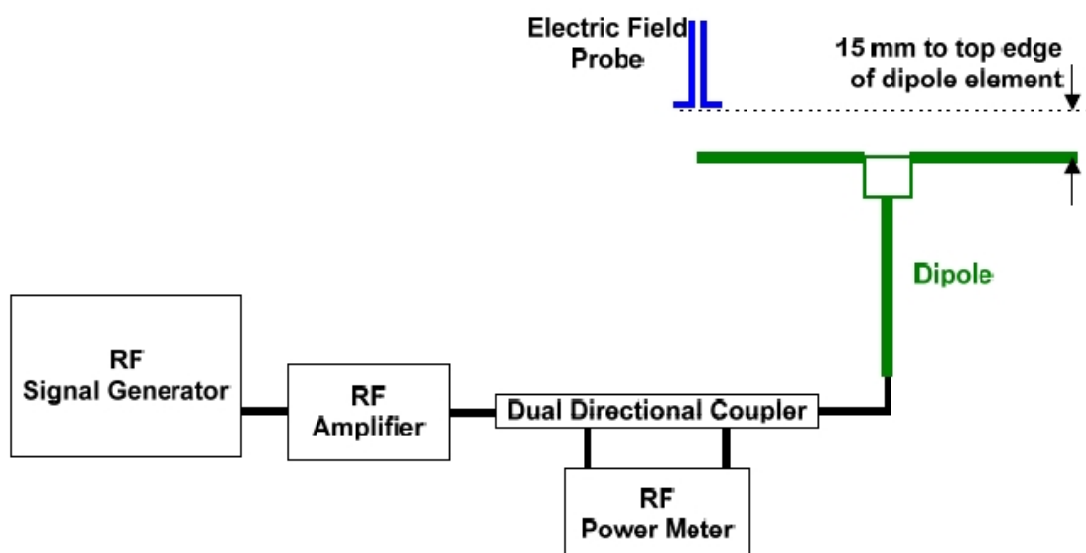


Figure 5 Dipole Validation Setup

Dipole Measurement Summary

E-Field Scan					
Mode	Frequency (MHz)	Input Power (mW)	Value		Test Date
CW	835	100	Target ¹ Value(V/m)	104.7	November 17, 2014
			Measured ² Value(V/m)	107.3	May 5, 2016
			Deviation ³ (%)	2.48	/
CW	1880	100	Target ¹ Value(V/m)	88.8	November 17, 2014
			Measured ² Value(V/m)	92.1	May 5, 2016
			Deviation ³ (%)	3.72	/

5.5 Modulation interference factor

For any specific fixed and repeatable modulated signal, a modulation interference factor (MIF, expressed in dB) may be developed that relates its interference potential to its steady-state rms signal level or average power level. This factor is a function only of the audio-frequency amplitude modulation characteristics of the signal and is the same for field-strength and conducted power measurements. It is important to emphasize that the MIF is valid only for a specific repeatable audio-frequency amplitude modulation characteristic. Any change in modulation characteristic requires determination and application of a new MIF.

The MIF may be determined using a radiated RF field or a conducted RF signal.

- Using RF illumination or conducted coupling, apply the specific modulated signal in question to the measurement system at a level within its confirmed operating dynamic range.
- Measure the steady-state rms level at the output of the fast probe or sensor.
- Measure the steady-state average level at the weighting output.

- d) Without changing the square-law detector or weighting system, and using RF illumination or conducted coupling, substitute for the specific modulated signal a 1 kHz, 80% amplitudemodulated carrier at the same frequency and adjust its strength until the level at the weighting output equals the step d) measurement.
- e) Without changing the carrier level from step e), remove the 1 kHz modulation and again measure the steady-state rms level indicated at the output of the fast probe or sensor.
- f) The MIF for the specific modulation characteristic is provided by the ratio of the step e) measurement to the step c) measurement, expressed in dB ($20 \times \log(\text{step e})/\text{step b})$).

MIF

Band	Worst case E-Field Modulation interference factor (dB)
GSM 850	3.62
GSM 1900	3.64
WCDMA Band II	-21.15
WCDMA Band V	-21.14

5.6 Conducted Output Power Measurement

Summary

The EUT is tested using an E5515C communications tester as controller unit to set test channels and maximum output power to the DUT, as well as for measuring the conducted power. Conducted output power was measured using an integrated RF connector and attached RF cable. This result contains conducted output power for the EUT.

Conducted Power Results

GSM 850	Conducted Power(dBm)		
	Channel 128	Channel 190	Channel 251
Test Results	32.23	32.37	32.39
GSM 1900	Conducted Power(dBm)		
	Channel 512	Channel 661	Channel 810
Test Results	29.21	29.00	29.18
UMTS Band II	Conducted Power(dBm)		
	Channel 9262	Channel 9400	Channel 9538
Test Results	22.11	22.33	22.38
UMTS Band V	Conducted Power(dBm)		
	Channel 4132	Channel 4183	Channel 4233
Test Results	22.88	22.83	22.91

5.7 Analysis of RF Air Interface Technologies

RF air interface technologies that have low power have been found to produce sufficiently low RF interference potential, so that it is possible to exempt them from the product testing specified in Clause 5. As described in 5.4.4. An RF air interface technology of a device is exempt from testing when its average antenna input power plus its MIF is ≤ 17 dBm for any of its operating modes.

5.8 Individual Mode Evaluations

Air Interface	Maximum average power (dBm)	Worst case MIF (dB)	Total (power +MIF,dBm)	C63.19 Testing Required
GSM 850	32.39	3.62	36.01	Yes
GSM 1900	29.21	3.64	32.85	Yes
WCDMA Band II	22.38	-21.15	1.23	No
WCDMA Band V	22.91	-21.14	1.77	No

Per ANSI C63.19-2011 RF Emissions testing for this device is required only for GSM voice modes. All other applicable air interfaces are exempt.

6 Test Results

6.1 ANSI C63.19-2011 Limits

Category	Telephone RF parameters < 960 MHz	
Near field	E-field emissions	
Category M1	50 to 55	dB (V/m)
Category M2	45 to 50	dB (V/m)
Category M3	40 to 45	dB (V/m)
Category M4	< 40	dB (V/m)
Category	Telephone RF parameters > 960 MHz	
Near field	E-field emissions	
Category M1	40 to 45	dB (V/m)
Category M2	35 to 40	dB (V/m)
Category M3	30 to 35	dB (V/m)
Category M4	< 30	dB (V/m)

6.2 Summary Test Results

GSM 850 Results

Channel	Frequency (MHz)	MIF(dB)	E-Field Emissions dB (V/m)	Power Drift (dB)	Category	Graph Results
High/251	848.8	3.62	35.39	-0.03	M4	Figure 8
Middle/190	836.6	3.62	35.23	-0.06	M4	Figure 9
Low/128	824.2	3.62	34.79	0.03	M4	Figure 10

GSM 1900 Results

Channel	Frequency (MHz)	MIF(dB)	E-Field Emissions dB (V/m)	Power Drift (dB)	Category	Graph Results
High/810	1909.8	3.64	26.63	-0.13	M4	Figure 11
Middle/661	1880	3.64	27.18	0.02	M4	Figure 12
Low/512	1850.2	3.64	25.95	0.02	M4	Figure 13

7 Measurement Uncertainty

No.	Error source	Type	Uncertainty Value (%)	Prob. Dist.	k	$c_i E$	$c_i H$	Standard Uncertainty (%) u_i (%) E	Degree of freedom V_{eff} or v_i
1	Probe Calibration	B	5.1	N	1	1	1	5.1	∞
2	Axial Isotropy	B	4.7	R	$\sqrt{3}$	1	1	2.7	∞
3	Sensor Displacement	B	16.5	R	$\sqrt{3}$	1	0.145	9.5	∞
4	Boundary Effects	B	2.4	R	$\sqrt{3}$	1	1	1.4	∞
5	Test Arch	B	7.2	R	$\sqrt{3}$	1	0	4.1	∞
6	Linearity	B	4.7	R	$\sqrt{3}$	1	1	2.7	∞
7	Scaling to Peak Envelope Power	B	2.0	R	$\sqrt{3}$	1	1	1.2	∞
8	System Detection Limit	B	1.0	R	$\sqrt{3}$	1	1	0.6	∞
9	Readout Electronics	B	0.3	N	1	1	1	0.3	∞
10	Response Time	B	0.8	R	$\sqrt{3}$	1	1	0.5	∞
11	Integration Time	B	2.6	R	$\sqrt{3}$	1	1	1.5	∞
12	RF Ambient Conditions	B	3.0	R	$\sqrt{3}$	1	1	1.7	∞
13	RF Reflections	B	12.0	R	$\sqrt{3}$	1	1	6.9	∞
14	Probe Positioner	B	1.2	R	$\sqrt{3}$	1	0.67	0.7	∞
15	Probe Positioning	A	4.7	R	$\sqrt{3}$	1	0.67	2.7	∞
16	Extra. And Interpolation	B	1.0	R	$\sqrt{3}$	1	1	0.6	∞
17	Device Positioning Vertical	B	4.7	R	$\sqrt{3}$	1	0.67	2.7	∞
18	Device Positioning Lateral	B	1.0	R	$\sqrt{3}$	1	1	0.6	∞
19	Device Holder and Phantom	B	2.4	R	$\sqrt{3}$	1	1	1.4	∞



20	Power Drift	B	5.0	R	$\sqrt{3}$	1	1	2.9	∞
21	Phantom Thickness	B	2.4	R	$\sqrt{3}$	1	0.67	1.4	∞
Combined standard uncertainty (%)								15.19	
Expanded Std. uncertainty on power (K=2)								30.38	
Expanded Std. uncertainty on field (K=2)								15.19	



8 Main Test Instruments

Name	Type	Serial Number	Calibration Date	Expiration Time
Power meter	Agilent E4417A	GB41291714	2015-05-22	2016-05-21
Power sensor	Agilent N8481H	MY50350004	2015-05-22	2016-05-21
Signal Generator	Agilent N5181A	MY50140143	2015-05-22	2016-05-21
Amplifier	IXA-020	0401	No Calibration Requested	
BTS	E5515C	MY48360988	2015-12-17	2016-11-26
E-Field Probe	ER3DV6	2303	2014-11-19	2016-11-18
DAE	DAE4	871	2015-11-17	2016-11-16
Validation Kit 835MHz	CD835V3	1133	2014-11-17	2016-11-16
Validation Kit 1880MHz	CD1880V3	1115	2014-11-17	2016-11-16
Hygrothermograph	NT-311	20150731	2015-07-16	2016-07-15
Audio Interference Analyzer	AIA	1012	No Calibration Requested	

*****END OF REPORT *****

ANNEX A: System Check Results

HAC_System Performance Check at 835MHz_E

DUT: Dipole 835 MHz; Type: CD835V3; SN:1023

Date: 2016-5-5

Communication System: CW; Frequency: 835 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature:22.3 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (7); SEMCAD X Version 14.6.10 (7164)

E Scan - measurement distance from the probe sensor center to CD835 Dipole = 15mm

2/Hearing Aid Compatibility Test (41x361x1): Measurement grid: dx=5mm, dy=5mm

Maximum value of peak Total field = 107.3 V/m

Applied MIF = 0.00 dB

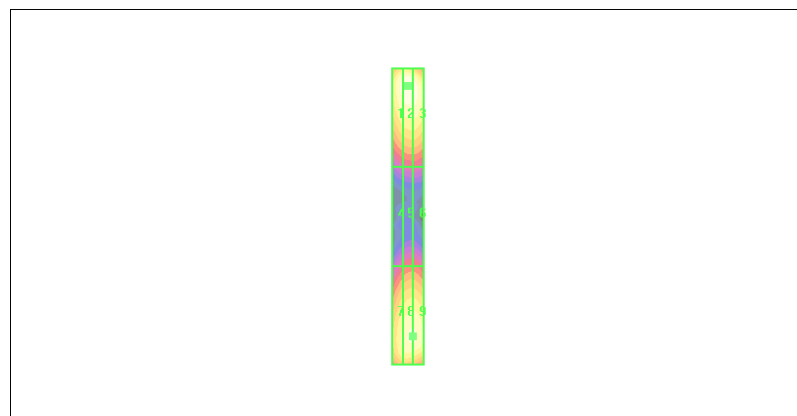
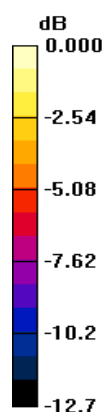
Device Reference Point: 0.000, 0.000, -6.30 mm

Reference Value = 91 V/m; Power Drift = 0.003 dB

Hearing Aid Near-Field Category: M4 (AWF 0 dB)

Peak E-field in V/m

Grid 1 101.2 M4	Grid 2 104.3 M4	Grid 3 101.5 M4
Grid 4 61.2 M4	Grid 5 64.23 M4	Grid 6 62.39 M4
Grid 7 104.5 M4	Grid 8 107.3 M4	Grid 9 104.3 M4



0 dB = 107.3V/m

Figure 6 System Performance Check 835MHz_E

HAC_System Performance Check at 1880MHz_E

DUT: Dipole 1880 MHz; Type: CD1880V3; SN: 1018

Date: 2016-5-5

Communication System: CW; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature: 22.3 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (7); SEMCAD X Version 14.6.10 (7164)

E Scan - measurement distance from the probe sensor center to CD1880 Dipole =

15mm/Hearing Aid Compatibility Test (41x181x1): Measurement grid: dx=5mm, dy=5mm

Maximum value of peak Total field = 92.1 V/m

Applied MIF = 0.00 dB

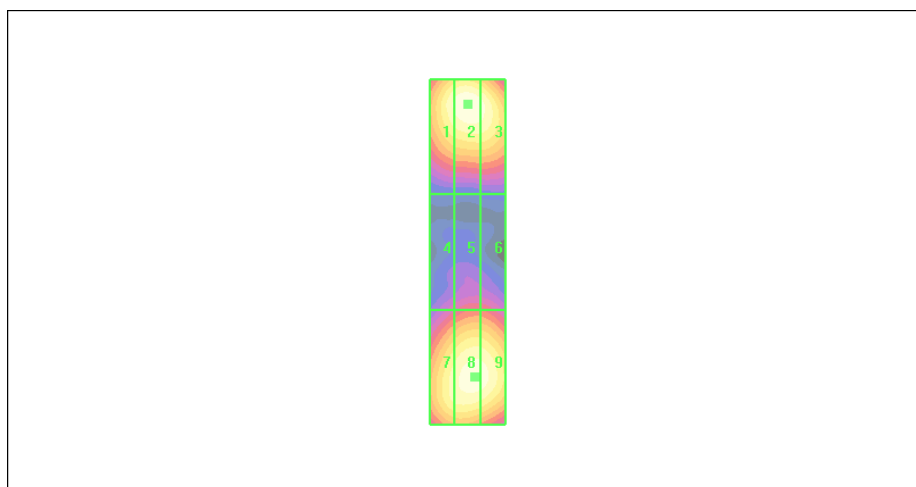
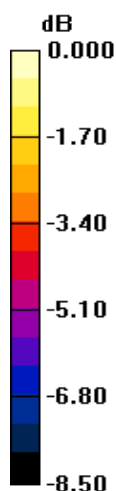
Device Reference Point: 0.000, 0.000, -6.30 mm

Reference Value = 86V/m; Power Drift = 0.002 dB

Hearing Aid Near-Field Category: M2 (AWF 0 dB)

Peak E-field in V/m

Grid 1 91.78 M2	Grid 2 98.10 M2	Grid 3 93.42M2
Grid 4 71.76 M3	Grid 5 73.56 M3	Grid 6 71.17 M3
Grid 7 87.15 M2	Grid 8 89.46 M2	Grid 9 89.01 M2



0 dB = 98.10V/m

Figure 7 System Performance Check 1880MHz_E



ANNEX B: Graph Results

HAC RF E-Field GSM 850 High

Date: 2016-5-5

Communication System: UID 10021 - DAA, GSM-FDD (TDMA, GMSK); Frequency: 848.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ S/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature: 22.3 °C Liquid Temperature: 21.5 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19;

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (8); SEMCAD X Version 14.6.10 (7331)

Lex522 GSM 850 HAC RF E-Field 2011 Device E-Field measurement (E-field scan for ANSI C63.19-2007 & -2011 compliance)/E Scan - ER3D: 15 mm from Probe Center to the Device High/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 43.99 V/m; Power Drift = -0.03 dB

Applied MIF = 3.62 dB

Maximum value of Total (interpolated) = 58.81 V/m

Lex522 GSM 850 HAC RF E-Field 2011 Device E-Field measurement (E-field scan for ANSI C63.19-2007 & -2011 compliance)/E Scan - ER3D: 15 mm from Probe Center to the Device High/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 43.99 V/m; Power Drift = -0.03 dB

Applied MIF = 3.62 dB

RF audio interference level = 35.26 dBV/m

Emission category: M4

MIF scaled E-field

Grid 1 M4 31.13 dBV/m	Grid 2 M4 34.75 dBV/m	Grid 3 M4 34.76 dBV/m
Grid 4 M4 32.53 dBV/m	Grid 5 M4 35.26 dBV/m	Grid 6 M4 35.26 dBV/m
Grid 7 M4 33.3 dBV/m	Grid 8 M4 35.39 dBV/m	Grid 9 M4 35.36 dBV/m

Category	Limits for E-Field Emissions < 960MHz	Limits for E-Field Emissions > 960MHz
M1	50 dBV/m - 55 dB V/m	40 dBV/m - 45 dB V/m
M2	45 dBV/m - 50 dB V/m	35 dBV/m - 40 dB V/m
M3	40 dBV/m - 45 dB V/m	30 dBV/m - 35 dB V/m
M4	<40 dBV/m	<30 dBV/m

Cursor:

Total = 35.39 dBV/m

E Category: M4

Location: -7, 25, 8.7 mm

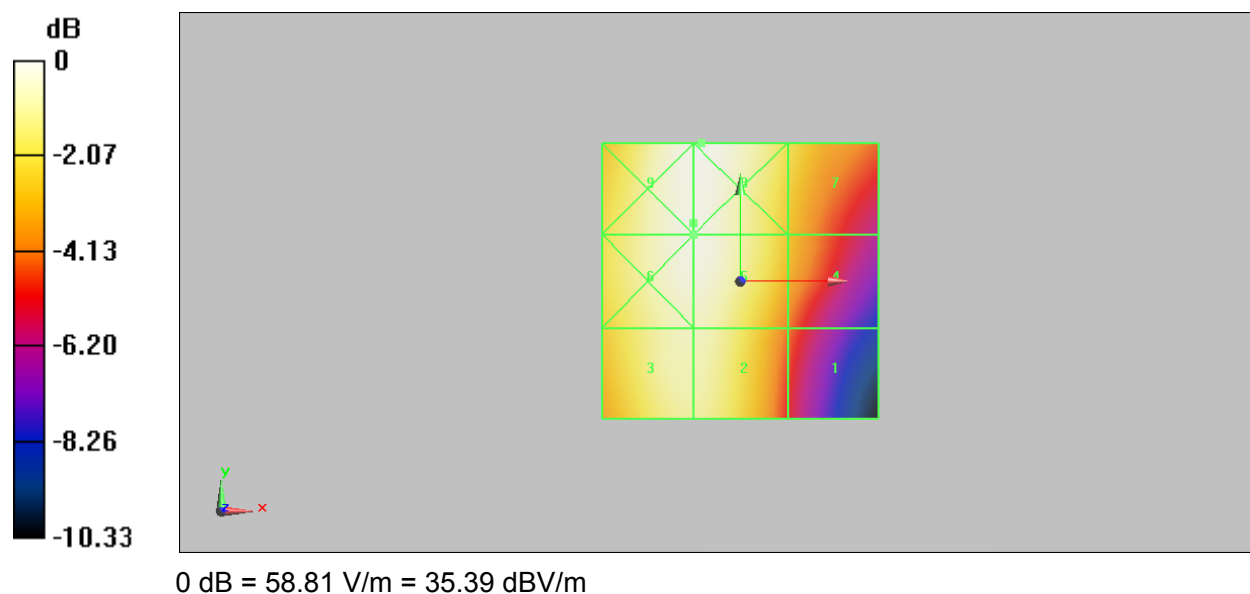


Figure 8 HAC RF E-Field GSM 850 Channel 251

**HAC RF E-Field GSM 850 Middle**

Date: 2016-5-5

Communication System: UID 10021 - DAA, GSM-FDD (TDMA, GMSK); Frequency: 836.6 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ S/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature: 22.3 °C Liquid Temperature: 21.5 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19;

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (8); SEMCAD X Version 14.6.10 (7331)

Lex522 GSM 850 HAC RF E-Field 2011 Device E-Field measurement (E-field scan for ANSI C63.19-2007 & -2011 compliance)/E Scan - ER3D: 15 mm from Probe Center to the Device Middle/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 43.53 V/m; Power Drift = -0.06 dB

Applied MIF = 3.62 dB

Maximum value of Total (interpolated) = 57.77 V/m

Lex522 GSM 850 HAC RF E-Field 2011 Device E-Field measurement (E-field scan for ANSI C63.19-2007 & -2011 compliance)/E Scan - ER3D: 15 mm from Probe Center to the Device Middle/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 43.53 V/m; Power Drift = -0.06 dB

Applied MIF = 3.62 dB

RF audio interference level = 35.17 dBV/m

Emission category: M4

MIF scaled E-field

Grid 1 M4 31.13 dBV/m	Grid 2 M4 34.65 dBV/m	Grid 3 M4 34.65 dBV/m
Grid 4 M4 32.39 dBV/m	Grid 5 M4 35.17 dBV/m	Grid 6 M4 35.17 dBV/m
Grid 7 M4 33.13 dBV/m	Grid 8 M4 35.23 dBV/m	Grid 9 M4 35.22 dBV/m

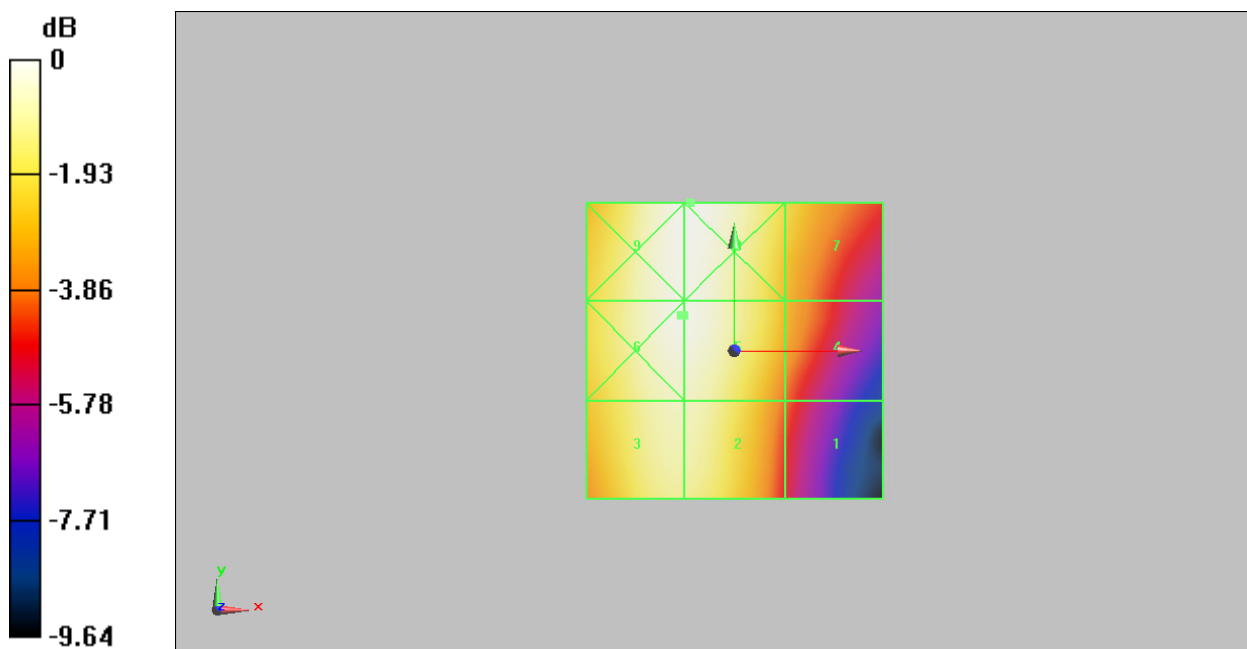
Category	Limits for E-Field Emissions < 960MHz	Limits for E-Field Emissions > 960MHz
M1	50 dBV/m - 55 dB V/m	40 dBV/m - 45 dB V/m
M2	45 dBV/m - 50 dB V/m	35 dBV/m - 40 dB V/m
M3	40 dBV/m - 45 dB V/m	30 dBV/m - 35 dB V/m
M4	<40 dBV/m	<30 dBV/m

Cursor:

Total = 35.23 dBV/m

E Category: M4

Location: -7.5, 25, 8.7 mm



0 dB = 57.77 V/m = 35.23 dBV/m

Figure 9 HAC RF E-Field GSM 850 Channel 190

HAC RF E-Field GSM 850 Low

Date: 2016-5-5

Communication System: UID 10021 - DAA, GSM-FDD (TDMA, GMSK); Frequency: 824.2 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ S/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature: 22.3 °C Liquid Temperature: 21.5 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19;

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (8); SEMCAD X Version 14.6.10 (7331)

Lex522 GSM 850 HAC RF E-Field 2011 Device E-Field measurement (E-field scan for ANSI C63.19-2007 & -2011 compliance)/E Scan - ER3D: 15 mm from Probe Center to the Device Low/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 41.93 V/m; Power Drift = 0.03 dB

Applied MIF = 3.62 dB

Maximum value of Total (interpolated) = 54.87 V/m

Lex522 GSM 850 HAC RF E-Field 2011 Device E-Field measurement (E-field scan for ANSI C63.19-2007 & -2011 compliance)/E Scan - ER3D: 15 mm from Probe Center to the Device Low/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 41.93 V/m; Power Drift = 0.03 dB

Applied MIF = 3.62 dB

RF audio interference level = 34.77 dBV/m

Emission category: M4

MIF scaled E-field

Grid 1 M4 31.06 dBV/m	Grid 2 M4 34.35 dBV/m	Grid 3 M4 34.37 dBV/m
Grid 4 M4 32.15 dBV/m	Grid 5 M4 34.77 dBV/m	Grid 6 M4 34.77 dBV/m
Grid 7 M4 32.79 dBV/m	Grid 8 M4 34.79 dBV/m	Grid 9 M4 34.77 dBV/m

Category	Limits for E-Field Emissions < 960MHz	Limits for E-Field Emissions > 960MHz
M1	50 dBV/m - 55 dB V/m	40 dBV/m - 45 dB V/m
M2	45 dBV/m - 50 dB V/m	35 dBV/m - 40 dB V/m
M3	40 dBV/m - 45 dB V/m	30 dBV/m - 35 dB V/m
M4	<40 dBV/m	<30 dBV/m

Cursor:

Total = 34.79 dBV/m

E Category: M4

Location: -7.5, 23, 8.7 mm

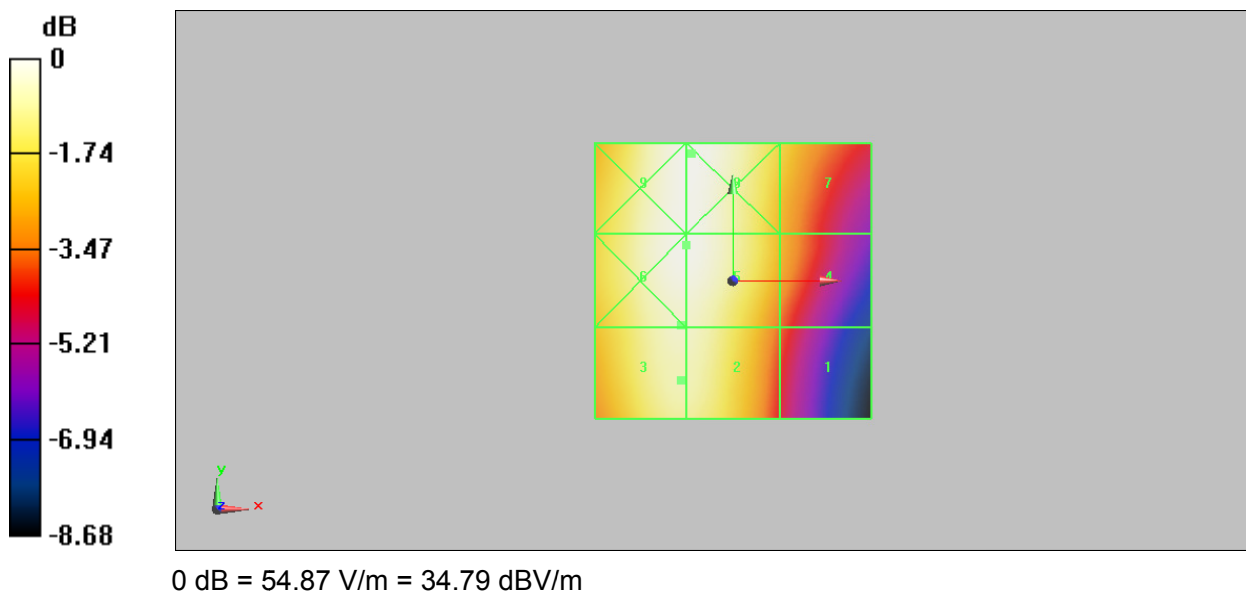


Figure 10 HAC RF E-Field GSM 850 Channel 128



HAC RF E-Field GSM 1900 High

Date: 2016-5-5

Communication System: UID 10021 - DAB, GSM-FDD (TDMA, GMSK); Frequency: 1909.8 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ S/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature: 22.3 °C Liquid Temperature: 21.5 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19;

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (8); SEMCAD X Version 14.6.10 (7331)

Lex522 GSM 1900 HAC RF E-Field/E Scan - ER3D: 15 mm from Probe Center to the Device High/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 6.594 V/m; Power Drift = -0.13 dB

Applied MIF = 3.64 dB

Maximum value of Total (interpolated) = 21.44 V/m

Lex522 GSM 1900 HAC RF E-Field/E Scan - ER3D: 15 mm from Probe Center to the Device High/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 6.594 V/m; Power Drift = -0.13 dB

Applied MIF = 3.64 dB

RF audio interference level = 23.68 dBV/m

Emission category: M4

MIF scaled E-field

Grid 1 M4 23.68 dBV/m	Grid 2 M4 26.63 dBV/m	Grid 3 M4 26.63 dBV/m
Grid 4 M4 23.39 dBV/m	Grid 5 M4 23.04 dBV/m	Grid 6 M4 24.54 dBV/m
Grid 7 M4 22.51 dBV/m	Grid 8 M4 22.7 dBV/m	Grid 9 M4 23.39 dBV/m

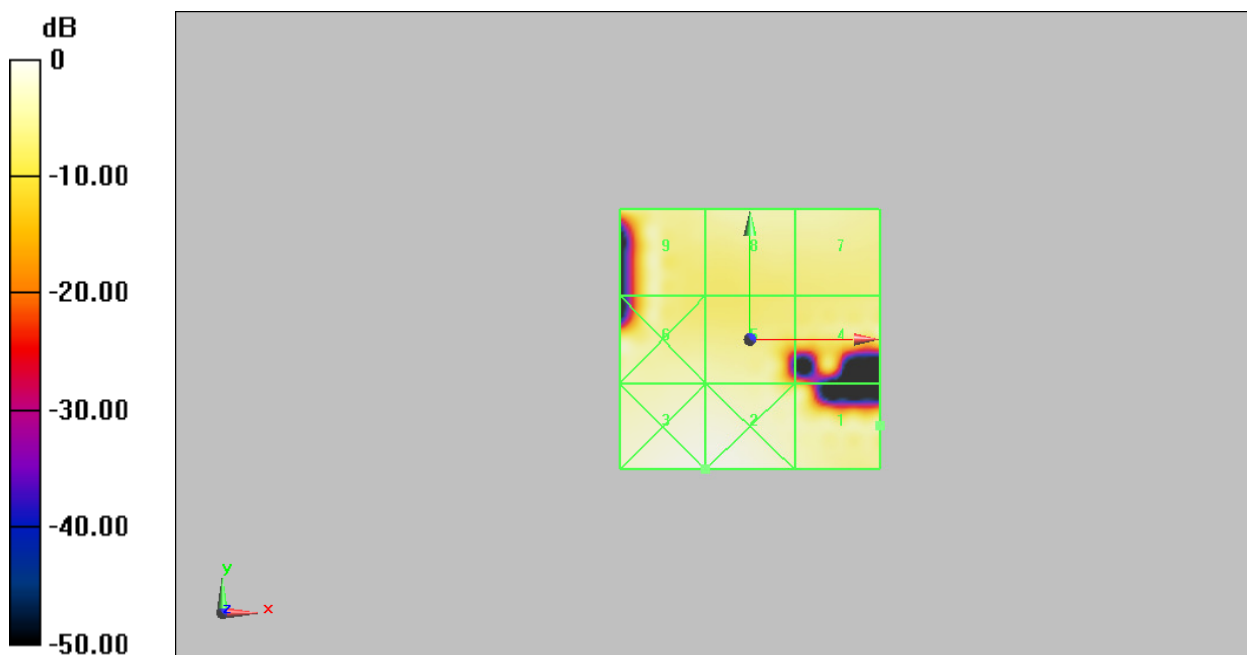
Category	Limits for E-Field Emissions < 960MHz	Limits for E-Field Emissions > 960MHz
M1	50 dBV/m - 55 dB V/m	40 dBV/m - 45 dB V/m
M2	45 dBV/m - 50 dB V/m	35 dBV/m - 40 dB V/m
M3	40 dBV/m - 45 dB V/m	30 dBV/m - 35 dB V/m
M4	<40 dBV/m	<30 dBV/m

Cursor:

Total = 26.63 dBV/m

E Category: M4

Location: -8.5, -25, 8.7 mm



0 dB = 21.44 V/m = 26.62 dBV/m

Figure 11 HAC RF E-Field GSM 1900 Channel 810

**HAC RF E-Field GSM 1900 Middle**

Date: 2016-5-5

Communication System: UID 10021 - DAB, GSM-FDD (TDMA, GMSK); Frequency: 1880 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ S/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature: 22.3 °C Liquid Temperature: 21.5 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19;

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (8); SEMCAD X Version 14.6.10 (7331)

Lex522 GSM 1900 HAC RF E-Field/E Scan - ER3D: 15 mm from Probe Center to the Device Middle/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 6.738 V/m; Power Drift = 0.020 dB

Applied MIF = 3.64 dB

Maximum value of Total (interpolated) = 22.85 V/m

Lex522 GSM 1900 HAC RF E-Field/E Scan - ER3D: 15 mm from Probe Center to the Device Middle/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 6.738 V/m; Power Drift = 0.020 dB

Applied MIF = 3.64 dB

RF audio interference level = 26.28 dBV/m

Emission category: M4

MIF scaled E-field

Grid 1 M4 24.75 dBV/m	Grid 2 M4 27.18 dBV/m	Grid 3 M4 27.04 dBV/m
Grid 4 M4 22.77 dBV/m	Grid 5 M4 22.94 dBV/m	Grid 6 M4 25.8 dBV/m
Grid 7 M4 25.12 dBV/m	Grid 8 M4 22.47 dBV/m	Grid 9 M4 26.28 dBV/m

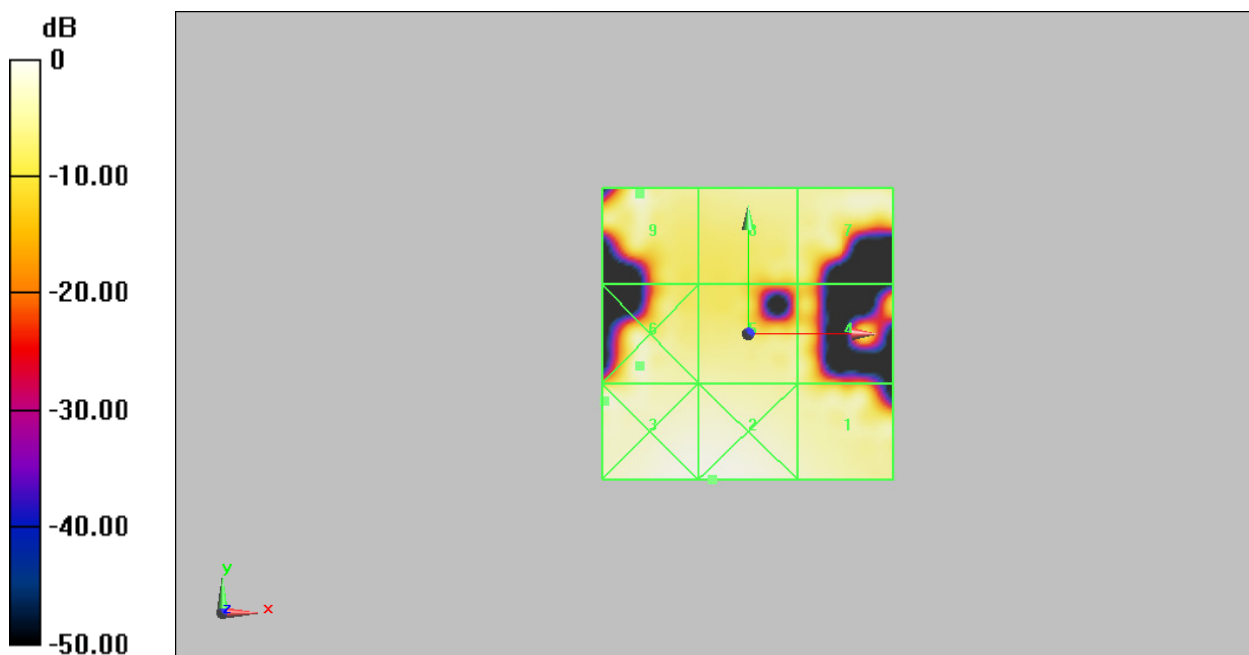
Category	Limits for E-Field Emissions < 960MHz	Limits for E-Field Emissions > 960MHz
M1	50 dBV/m - 55 dB V/m	40 dBV/m - 45 dB V/m
M2	45 dBV/m - 50 dB V/m	35 dBV/m - 40 dB V/m
M3	40 dBV/m - 45 dB V/m	30 dBV/m - 35 dB V/m
M4	<40 dBV/m	<30 dBV/m

Cursor:

Total = 27.18 dBV/m

E Category: M4

Location: -6, -25, 8.7 mm



0 dB = 22.85 V/m = 27.18 dBV/m

Figure 12 HAC RF E-Field GSM 1900 Channel 661

**HAC RF E-Field GSM 1900 Low**

Date: 2016-5-5

Communication System: UID 10021 - DAB, GSM-FDD (TDMA, GMSK); Frequency: 1850.2 MHz; Duty Cycle: 1:8.30042

Medium parameters used: $\sigma = 0$ S/m, $\epsilon_r = 1$; $\rho = 1000$ kg/m³

Ambient Temperature: 22.3 °C Liquid Temperature: 21.5 °C

Phantom section: RF Section

DASY5 Configuration:

Sensor-Surface: 4mm (Mechanical Surface Detection)

Probe: ER3DV6 - SN2303; ConvF(1, 1, 1); Calibrated: 2014-11-19;

Electronics: DAE4 Sn871; Calibrated: 2015-11-17

Phantom: HAC Test Arch with AMCC; Type: SD HAC P01 BA;

Measurement SW: DASY52, Version 52.8 (8); SEMCAD X Version 14.6.10 (7331)

Lex522 GSM 1900 HAC RF E-Field/E Scan - ER3D: 15 mm from Probe Center to the Device Low/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 5.820 V/m; Power Drift = 0.023 dB

Applied MIF = 3.64 dB

Maximum value of Total (interpolated) = 19.85 V/m

Lex522 GSM 1900 HAC RF E-Field/E Scan - ER3D: 15 mm from Probe Center to the Device Low/Hearing Aid Compatibility Test (101x101x1): Interpolated grid: dx=0.5000 mm, dy=0.5000 mm

Device Reference Point: 0, 0, -6.3 mm

Reference Value = 5.820 V/m; Power Drift = 0.023 dB

Applied MIF = 3.64 dB

RF audio interference level = 22.42 dBV/m

Emission category: M4

MIF scaled E-field

Grid 1 M4 24.1 dBV/m	Grid 2 M4 25.95 dBV/m	Grid 3 M4 25.84 dBV/m
Grid 4 M4 21.48 dBV/m	Grid 5 M4 22.07 dBV/m	Grid 6 M4 21.99 dBV/m
Grid 7 M4 22.13 dBV/m	Grid 8 M4 22.42 dBV/m	Grid 9 M4 21.22 dBV/m

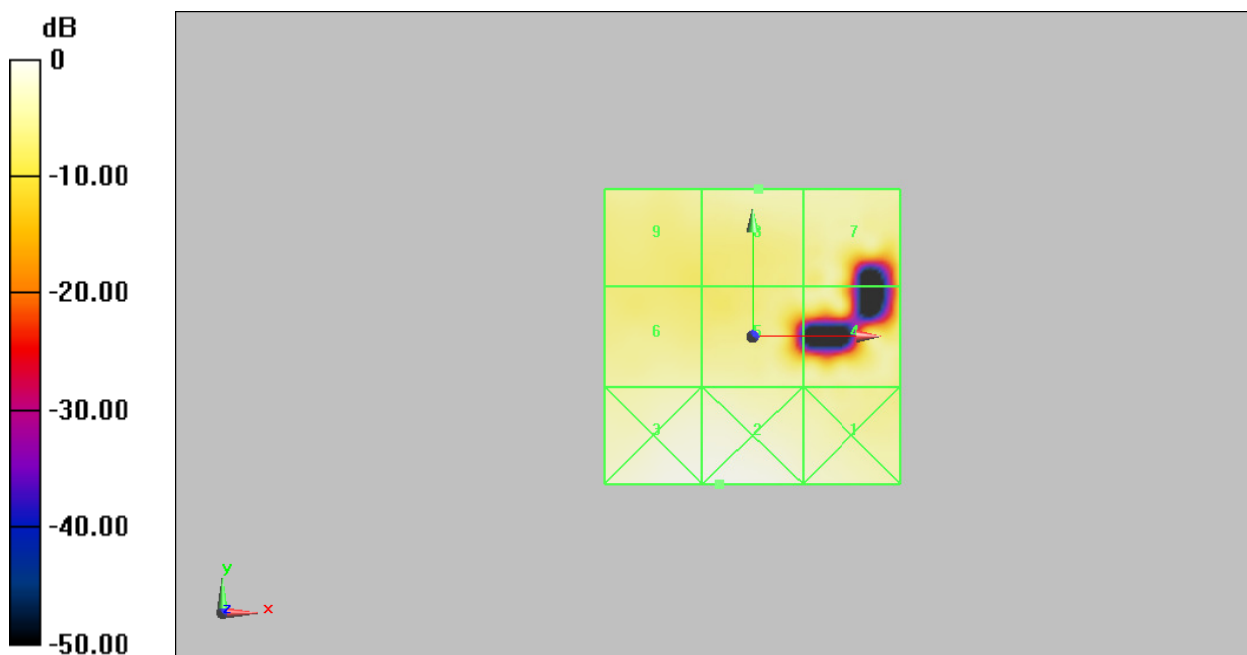
Category	Limits for E-Field Emissions < 960MHz	Limits for E-Field Emissions > 960MHz
M1	50 dBV/m - 55 dB V/m	40 dBV/m - 45 dB V/m
M2	45 dBV/m - 50 dB V/m	35 dBV/m - 40 dB V/m
M3	40 dBV/m - 45 dB V/m	30 dBV/m - 35 dB V/m
M4	<40 dBV/m	<30 dBV/m

Cursor:

Total = 25.95 dBV/m

E Category: M4

Location: -5.5, -25, 8.7 mm



0 dB = 19.85 V/m = 25.96 dBV/m

Figure 13 HAC RF E-Field GSM 1900 Channel 512

ANNEX C: E-Probe Calibration Certificate

**Calibration Laboratory of
Schmid & Partner
Engineering AG**
Zeughausstrasse 43, 8004 Zurich, Switzerland



S Schweizerischer Kalibrierdienst
C Service suisse d'étalonnage
S Servizio svizzero di taratura
S Swiss Calibration Service

Accredited by the Swiss Accreditation Service (SAS)
The Swiss Accreditation Service is one of the signatories to the EA
Multilateral Agreement for the recognition of calibration certificates

Accreditation No.: **SCS 108**

Client **TA-Shanghai (Auden)**

Certificate No: **ER3-2303_Nov14**

CALIBRATION CERTIFICATE

Object **ER3DV6 - SN:2303**

Calibration procedure(s) **QA CAL-02.v8, QA CAL-25.v6**
Calibration procedure for E-field probes optimized for close near field
evaluations in air

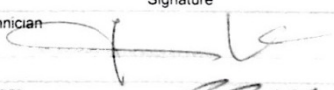
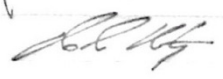
Calibration date **November 19, 2014**

This calibration certificate documents the traceability to national standards, which realize the physical units of measurements (SI).
The measurements and the uncertainties with confidence probability are given on the following pages and are part of the certificate.

All calibrations have been conducted in the closed laboratory facility environment temperature $(22 \pm 3)^\circ\text{C}$ and humidity $< 70\%$.

Calibration Equipment used (M&TE critical for calibration)

Primary Standards	ID	Cal Date (Certificate No.)	Scheduled Calibration
Power meter E4419B	GB41293874	03-Apr-14 (No. 217-01911)	Apr-15
Power sensor E4412A	MY41498087	03-Apr-14 (No. 217-01911)	Apr-15
Reference 3 dB Attenuator	SN S5054 (3c)	03-Apr-14 (No. 217-01915)	Apr-15
Reference 20 dB Attenuator	SN S5277 (20x)	03-Apr-14 (No. 217-01919)	Apr-15
Reference 30 dB Attenuator	SN S5129 (30b)	03-Apr-14 (No. 217-01920)	Apr-15
Reference Probe ER3DV6	SN 2328	08-Oct-14 (No. ER3-2328_Oct14)	Oct-15
DAE4	SN 789	30-Apr-14 (No. DAE4-789_Apr14)	Apr-15
Secondary Standards	ID	Check Date (in house)	Scheduled Check
RF generator HP 8648C	US3642U01700	4-Aug-99 (in house check Apr-13)	In house check Apr-16
Network Analyzer HP 8753E	US37390585	18-Oct-01 (in house check Oct-14)	In house check Oct-15

	Name	Function	Signature
Calibrated by:	Jeton Kastrati	Laboratory Technician	
Approved by:	Katja Pokovic	Technical Manager	
This calibration certificate shall not be reproduced except in full without written approval of the laboratory			Issued November 21, 2014

Calibration Laboratory of
Schmid & Partner
Engineering AG
Zeughausstrasse 43, 8004 Zurich, Switzerland



S Schweizerischer Kalibrierdienst
C Service suisse d'étalonnage
S Servizio svizzero di taratura
S Swiss Calibration Service

Accredited by the Swiss Accreditation Service (SAS)

Accreditation No.: **SCS 108**

The Swiss Accreditation Service is one of the signatories to the EA
Multilateral Agreement for the recognition of calibration certificates

Glossary:

NORM _{x,y,z}	sensitivity in free space
DCP	diode compression point
CF	crest factor (1/duty_cycle) of the RF signal
A, B, C, D	modulation dependent linearization parameters
Polarization φ	φ rotation around probe axis
Polarization ϑ	ϑ rotation around an axis that is in the plane normal to probe axis (at measurement center), i.e., $\vartheta = 0$ is normal to probe axis
Connector Angle	information used in DASY system to align probe sensor X to the robot coordinate system

Calibration is Performed According to the Following Standards:

- IEEE Std 1309-2005, "IEEE Standard for calibration of electromagnetic field sensors and probes, excluding antennas, from 9 kHz to 40 GHz", December 2005
- CTIA Test Plan for Hearing Aid Compatibility, April 2010.

Methods Applied and Interpretation of Parameters:

- NORM_{x,y,z}**: Assessed for E-field polarization $\vartheta = 0$ for XY sensors and $\vartheta = 90$ for Z sensor ($f \leq 900$ MHz in TEM-cell; $f > 1800$ MHz: R22 waveguide).
- NORM(f)_{x,y,z}** = NORM_{x,y,z} * frequency_response (see Frequency Response Chart).
- DCP_{x,y,z}**: DCP are numerical linearization parameters assessed based on the data of power sweep with CW signal (no uncertainty required). DCP does not depend on frequency nor media.
- PAR**: PAR is the Peak to Average Ratio that is not calibrated but determined based on the signal characteristics
- A_{x,y,z}; B_{x,y,z}; C_{x,y,z}; D_{x,y,z}; VR_{x,y,z}**: A, B, C, D are numerical linearization parameters assessed based on the data of power sweep for specific modulation signal. The parameters do not depend on frequency nor media. VR is the maximum calibration range expressed in RMS voltage across the diode.
- Spherical isotropy (3D deviation from isotropy)**: in a locally homogeneous field realized using an open waveguide setup.
- Sensor Offset**: The sensor offset corresponds to the offset of virtual measurement center from the probe tip (on probe axis). No tolerance required.
- Connector Angle**: The angle is assessed using the information gained by determining the NORM_x (no uncertainty required).



ER3DV6 – SN:2303

November 19, 2014

Probe ER3DV6

SN:2303

Manufactured: November 6, 2002
Calibrated: November 19, 2014

Calibrated for DASY/EASY Systems
(Note: non-compatible with DASY2 system!)

ER3DV6- SN:2303

November 19, 2014

DASY/EASY - Parameters of Probe: ER3DV6 - SN:2303

Basic Calibration Parameters

	Sensor X	Sensor Y	Sensor Z	Unc (k=2)
Norm ($\mu\text{V}/(\text{V}/\text{m})^2$)	1.39	1.42	1.44	$\pm 10.1\%$
DCP (mV) ^B	100.8	99.6	102.6	

Modulation Calibration Parameters

UID	Communication System Name		A dB	B dB $\sqrt{\mu\text{V}}$	C	D dB	VR mV	Unc ^E (k=2)
0	CW	X	0.0	0.0	1.0	0.00	182.5	$\pm 3.0\%$
		Y	0.0	0.0	1.0		183.8	
		Z	0.0	0.0	1.0		225.1	
10021-DAB	GSM-FDD (TDMA, GMSK)	X	7.38	87.0	24.1	9.39	130.0	$\pm 1.7\%$
		Y	8.61	89.7	25.2		132.9	
		Z	4.01	75.5	19.0		148.0	

The reported uncertainty of measurement is stated as the standard uncertainty of measurement multiplied by the coverage factor $k=2$, which for a normal distribution corresponds to a coverage probability of approximately 95%.

^B Numerical linearization parameter: uncertainty not required

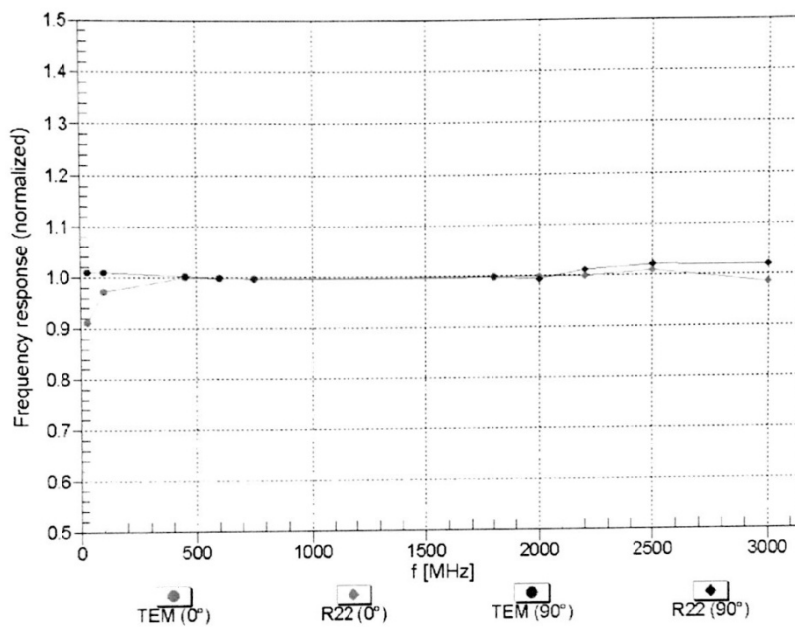
^E Uncertainty is determined using the max. deviation from linear response applying rectangular distribution and is expressed for the square of the field value

ER3DV6- SN:2303

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Frequency Response of E-Field

(TEM-Cell:ifi110 EXX, Waveguide: R22)

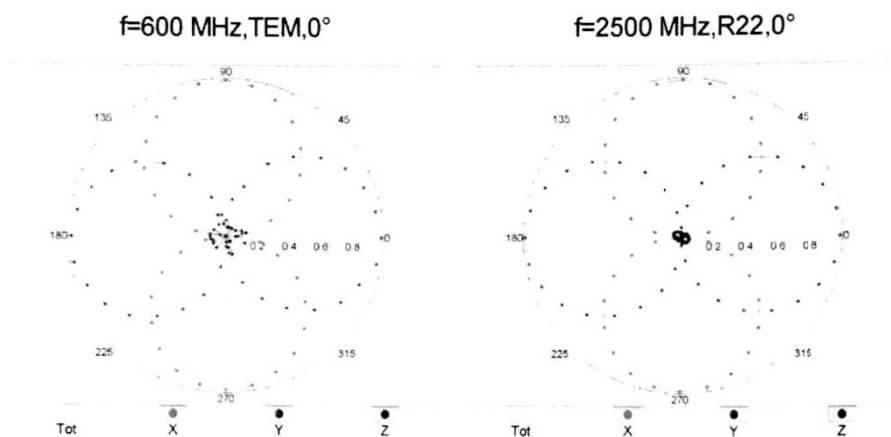


Uncertainty of Frequency Response of E-field: $\pm 6.3\%$ (k=2)

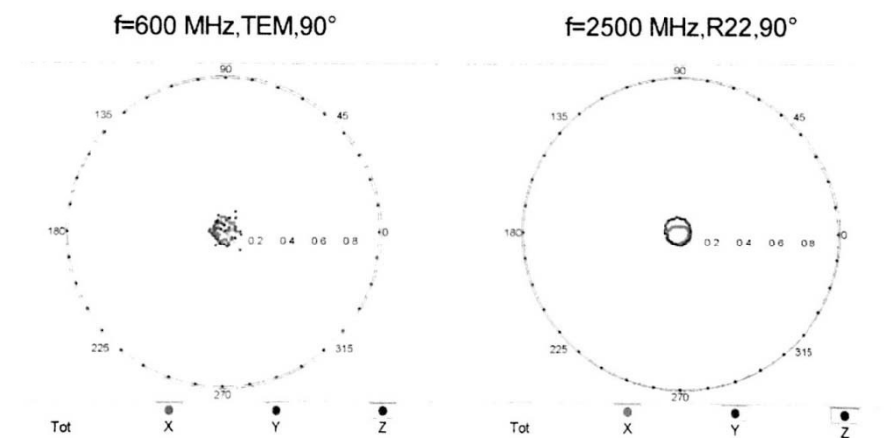
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November 19, 2014

Receiving Pattern (ϕ), $\theta = 0^\circ$



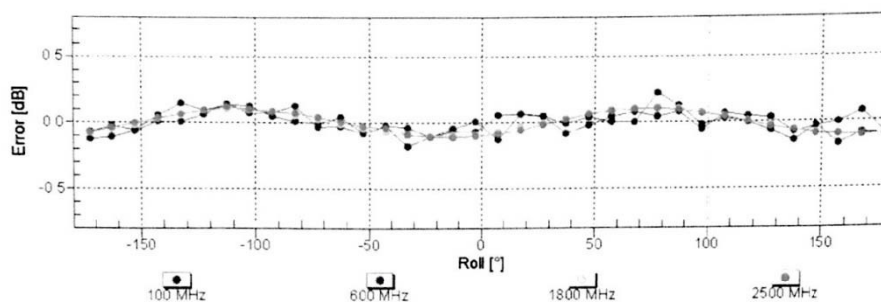
Receiving Pattern (ϕ), $\theta = 90^\circ$



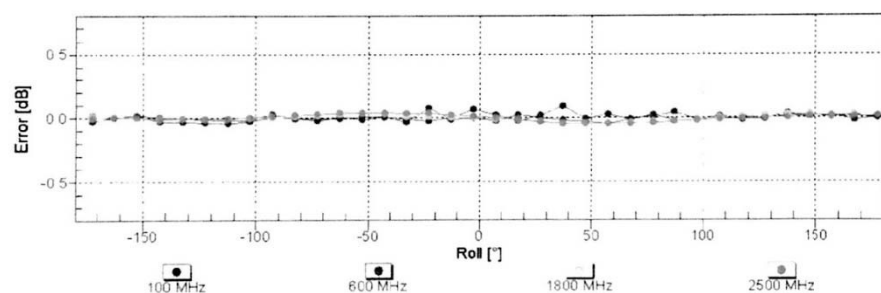
ER3DV6- SN:2303

November 19, 2014

Receiving Pattern (ϕ), $\theta = 0^\circ$


Uncertainty of Axial Isotropy Assessment: $\pm 0.5\%$ ($k=2$)

Receiving Pattern (ϕ), $\theta = 90^\circ$

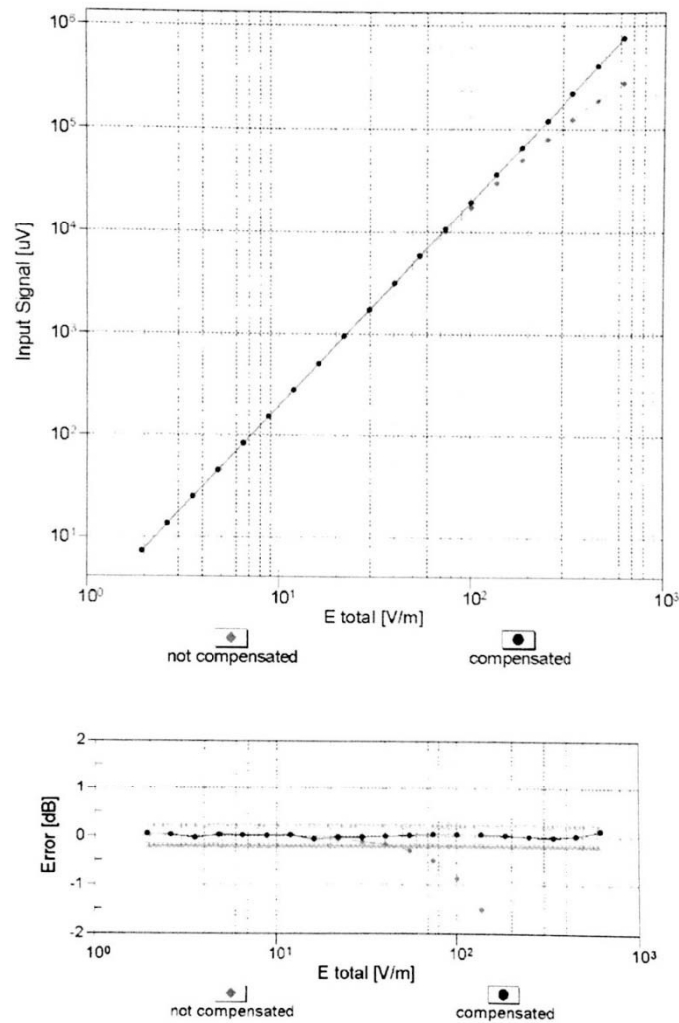

Uncertainty of Axial Isotropy Assessment: $\pm 0.5\%$ ($k=2$)

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Dynamic Range f(E-field)

(TEM cell , f = 900 MHz)

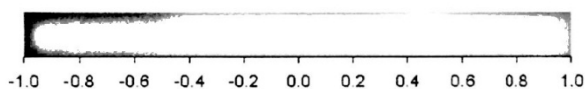
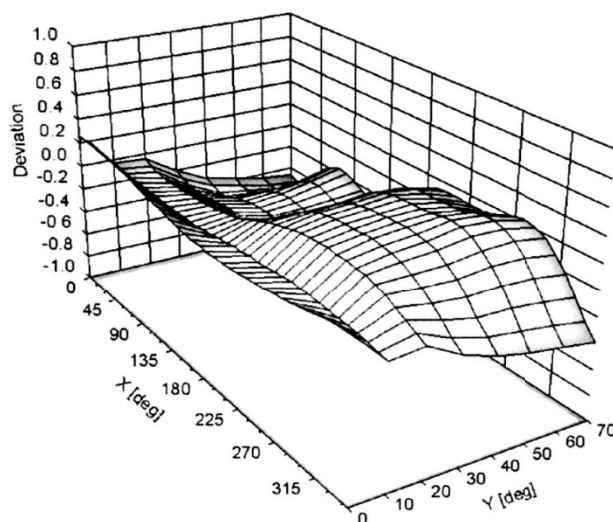


Uncertainty of Linearity Assessment: $\pm 0.6\%$ ($k=2$)

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Deviation from Isotropy in Air

Error (ϕ , θ), $f = 900$ MHz

Uncertainty of Spherical Isotropy Assessment: $\pm 2.6\%$ ($k=2$)



ER3DV6- SN:2303

November 19, 2014

DASY/EASY - Parameters of Probe: ER3DV6 - SN:2303**Other Probe Parameters**

Sensor Arrangement	Rectangular
Connector Angle (°)	27.3
Mechanical Surface Detection Mode	enabled
Optical Surface Detection Mode	disabled
Probe Overall Length	337 mm
Probe Body Diameter	10 mm
Tip Length	10 mm
Tip Diameter	8 mm
Probe Tip to Sensor X Calibration Point	2.5 mm
Probe Tip to Sensor Y Calibration Point	2.5 mm
Probe Tip to Sensor Z Calibration Point	2.5 mm

ANNEX D: CD835V3 Dipole Calibration Certificate

**Calibration Laboratory of
Schmid & Partner
Engineering AG**
Zeughausstrasse 43, 8004 Zurich, Switzerland



S Schweizerischer Kalibrierdienst
C Service suisse d'étalonnage
S Servizio svizzero di taratura
S Swiss Calibration Service

Accredited by the Swiss Accreditation Service (SAS)
The Swiss Accreditation Service is one of the signatories to the EA
Multilateral Agreement for the recognition of calibration certificates

Accreditation No.: **SCS 108**

Client **TA-Shanghai (Auden)**

Certificate No: **CD835V3-1133_Nov14**

CALIBRATION CERTIFICATE																																																											
Object	CD835V3 - SN: 1133																																																										
Calibration procedure(s)	QA CAL-20.v6 Calibration procedure for dipoles in air																																																										
Calibration date:	November 17, 2014																																																										
This calibration certificate documents the traceability to national standards, which realize the physical units of measurements (SI). The measurements and the uncertainties with confidence probability are given on the following pages and are part of the certificate. All calibrations have been conducted in the closed laboratory facility: environment temperature (22 ± 3)°C and humidity < 70%. Calibration Equipment used (M&TE critical for calibration) <table border="1"> <thead> <tr> <th>Primary Standards</th> <th>ID #</th> <th>Cal Date (Certificate No.)</th> <th>Scheduled Calibration</th> </tr> </thead> <tbody> <tr> <td>Power meter EPM-442A</td> <td>GB37480704</td> <td>07-Oct-14 (No. 217-02020)</td> <td>Oct-15</td> </tr> <tr> <td>Power sensor HP 8481A</td> <td>US37292783</td> <td>07-Oct-14 (No. 217-02020)</td> <td>Oct-15</td> </tr> <tr> <td>Power sensor HP 8481A</td> <td>MY41092317</td> <td>07-Oct-14 (No. 217-02021)</td> <td>Oct-15</td> </tr> <tr> <td>Reference 10 dB Attenuator</td> <td>SN: 5047.2 / 06327</td> <td>03-Apr-14 (No. 217-01921)</td> <td>Apr-15</td> </tr> <tr> <td>Probe ER3DV6</td> <td>SN: 2336</td> <td>30-Dec-13 (No. ER3-2336_Dec13)</td> <td>Dec-14</td> </tr> <tr> <td>Probe H3DV6</td> <td>SN: 6065</td> <td>30-Dec-13 (No. H3-6065_Dec13)</td> <td>Dec-14</td> </tr> <tr> <td>DAE4</td> <td>SN: 601</td> <td>18-Aug-14 (No. DAE4-601_Aug14)</td> <td>Aug-15</td> </tr> </tbody> </table> <table border="1"> <thead> <tr> <th>Secondary Standards</th> <th>ID #</th> <th>Check Date (in house)</th> <th>Scheduled Check</th> </tr> </thead> <tbody> <tr> <td>Power meter Agilent 4419B</td> <td>SN: GB42420191</td> <td>09-Oct-09 (in house check Sep-14)</td> <td>In house check: Sep-16</td> </tr> <tr> <td>Power sensor HP E4412A</td> <td>SN: US38485102</td> <td>05-Jan-10 (in house check Sep-14)</td> <td>In house check: Sep-16</td> </tr> <tr> <td>Power sensor HP 8482A</td> <td>SN: US37295597</td> <td>09-Oct-09 (in house check Sep-14)</td> <td>In house check: Sep-16</td> </tr> <tr> <td>Network Analyzer HP 8753E</td> <td>US37390585</td> <td>18-Oct-01 (in house check Oct-14)</td> <td>In house check: Oct-15</td> </tr> <tr> <td>RF generator R&S SMT-06</td> <td>SN: 832283/011</td> <td>27-Aug-12 (in house check Oct-13)</td> <td>In house check: Oct-16</td> </tr> </tbody> </table>				Primary Standards	ID #	Cal Date (Certificate No.)	Scheduled Calibration	Power meter EPM-442A	GB37480704	07-Oct-14 (No. 217-02020)	Oct-15	Power sensor HP 8481A	US37292783	07-Oct-14 (No. 217-02020)	Oct-15	Power sensor HP 8481A	MY41092317	07-Oct-14 (No. 217-02021)	Oct-15	Reference 10 dB Attenuator	SN: 5047.2 / 06327	03-Apr-14 (No. 217-01921)	Apr-15	Probe ER3DV6	SN: 2336	30-Dec-13 (No. ER3-2336_Dec13)	Dec-14	Probe H3DV6	SN: 6065	30-Dec-13 (No. H3-6065_Dec13)	Dec-14	DAE4	SN: 601	18-Aug-14 (No. DAE4-601_Aug14)	Aug-15	Secondary Standards	ID #	Check Date (in house)	Scheduled Check	Power meter Agilent 4419B	SN: GB42420191	09-Oct-09 (in house check Sep-14)	In house check: Sep-16	Power sensor HP E4412A	SN: US38485102	05-Jan-10 (in house check Sep-14)	In house check: Sep-16	Power sensor HP 8482A	SN: US37295597	09-Oct-09 (in house check Sep-14)	In house check: Sep-16	Network Analyzer HP 8753E	US37390585	18-Oct-01 (in house check Oct-14)	In house check: Oct-15	RF generator R&S SMT-06	SN: 832283/011	27-Aug-12 (in house check Oct-13)	In house check: Oct-16
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Calibrated by:	Name Leif Klysner	Function Laboratory Technician	Signature 																																																								
Approved by:	Fin Bornholt	Deputy Technical Manager																																																									
Issued: November 19, 2014 This calibration certificate shall not be reproduced except in full without written approval of the laboratory.																																																											

Certificate No: CD835V3-1133_Nov14

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**Calibration Laboratory of
Schmid & Partner
Engineering AG**
Zeughausstrasse 43, 8004 Zurich, Switzerland



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C Service suisse d'étalonnage
S Servizio svizzero di taratura
S Swiss Calibration Service

Accredited by the Swiss Accreditation Service (SAS)

The Swiss Accreditation Service is one of the signatories to the EA
Multilateral Agreement for the recognition of calibration certificates

Accreditation No.: **SCS 108**

References

- [1] ANSI-C63.19-2007
American National Standard for Methods of Measurement of Compatibility between Wireless Communications Devices and Hearing Aids.
- [2] ANSI-C63.19-2011
American National Standard, Methods of Measurement of Compatibility between Wireless Communications Devices and Hearing Aids.

Methods Applied and Interpretation of Parameters:

- **Coordinate System:** y-axis is in the direction of the dipole arms. z-axis is from the basis of the antenna (mounted on the table) towards its feed point between the two dipole arms. x-axis is normal to the other axes. In coincidence with the standards [1], the measurement planes (probe sensor center) are selected to be at a distance of 10 mm (15 mm for [2]) above the top metal edge of the dipole arms.
- **Measurement Conditions:** Further details are available from the hardcopies at the end of the certificate. All figures stated in the certificate are valid at the frequency indicated. The forward power to the dipole connector is set with a calibrated power meter connected and monitored with an auxiliary power meter connected to a directional coupler. While the dipole under test is connected, the forward power is adjusted to the same level.
- **Antenna Positioning:** The dipole is mounted on a HAC Test Arch phantom using the matching dipole positioner with the arms horizontal and the feeding cable coming from the floor. The measurements are performed in a shielded room with absorbers around the setup to reduce the reflections. It is verified before the mounting of the dipole under the Test Arch phantom, that its arms are perfectly in a line. It is installed on the HAC dipole positioner with its arms parallel below the dielectric reference wire and able to move elastically in vertical direction without changing its relative position to the top center of the Test Arch phantom. The vertical distance to the probe is adjusted after dipole mounting with a DASY5 Surface Check job. Before the measurement, the distance between phantom surface and probe tip is verified. The proper measurement distance is selected by choosing the matching section of the HAC Test Arch phantom with the proper device reference point (upper surface of the dipole) and the matching grid reference point (tip of the probe) considering the probe sensor offset. The vertical distance to the probe is essential for the accuracy.
- **Feed Point Impedance and Return Loss:** These parameters are measured using a HP 8753E Vector Network Analyzer. The impedance is specified at the SMA connector of the dipole. The influence of reflections was eliminating by applying the averaging function while moving the dipole in the air, at least 70cm away from any obstacles.
- **E-field distribution:** E field is measured in the x-y-plane with an isotropic ER3D-field probe with 100 mW forward power to the antenna feed point. In accordance with [1] and [2], the scan area is 20mm wide, its length exceeds the dipole arm length (180 or 90mm). The sensor center is 10 mm (15 mm for [2]) (in z) above the metal top of the dipole arms. Two 3D maxima are available near the end of the dipole arms. Assuming the dipole arms are perfectly in one line, the average of these two maxima (in subgrid 2 and subgrid 8) is determined to compensate for any non-parallelity to the measurement plane as well as the sensor displacement. The E-field value stated as calibration value represents the maximum of the interpolated 3D-E-field, in the plane above the dipole surface.
- **H-field distribution:** H-field is measured with an isotropic H-field probe with 100mW forward power to the antenna feed point, in the x-y-plane. The scan area and sensor distance is equivalent to the E-field scan. The maximum of the field is available at the center (subgrid 5) above the feed point. The H-field value stated as calibration value represents the maximum of the interpolated H-field, 10mm above the dipole surface at the feed point.

The reported uncertainty of measurement is stated as the standard uncertainty of measurement multiplied by the coverage factor $k=2$, which for a normal distribution corresponds to a coverage probability of approximately 95%.

Measurement Conditions

DASY system configuration, as far as not given on page 1.

DASY Version	DASY5	V52.8.8
Phantom	HAC Test Arch	
Distance Dipole Top - Probe Center	10 mm	
Scan resolution	dx, dy = 5 mm	
Frequency	835 MHz $\pm$ 1 MHz	
Input power drift	< 0.05 dB	

Maximum Field values at 835 MHz

H-field 10 mm above dipole surface	condition	interpolated maximum
Maximum measured	100 mW input power	0.446 A/m $\pm$ 8.2 % (k=2)

E-field 10 mm above dipole surface	condition	Interpolated maximum
Maximum measured above high end	100 mW input power	163.8 V/m = 44.29 dBV/m
Maximum measured above low end	100 mW input power	155.5 V/m = 43.84 dBV/m
Averaged maximum above arm	100 mW input power	159.7 V/m $\pm$ 12.8 % (k=2)

E-field 15 mm above dipole surface	condition	Interpolated maximum
Maximum measured above high end	100 mW input power	104.7 V/m = 40.40 dBV/m
Maximum measured above low end	100 mW input power	102.5 V/m = 40.21 dBV/m
Averaged maximum above arm	100 mW input power	103.6 V/m $\pm$ 12.8 % (k=2)